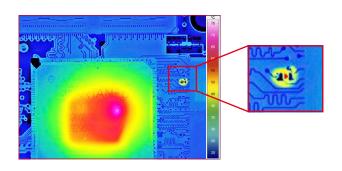


Automated Testing Solution E-LIT

Electronic/Semiconductor Testing Using Active Lock-in Thermography

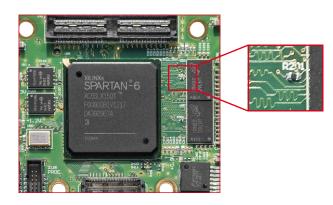




E-LIT – Automated testing solution system allows non-contact failure inspection of semiconductor material during the manufacturing process. Inhomogeneous temperature distribution, local power loss can be measured with Lock-in Thermography. This is achieved by using the shortest measurement times combined with a high-performance thermographic camera and a specialised lock-in procedure.

The power supply for this process is clocked with a synchronisation module and failures that produce mK or even μ K differences are reliably detected.

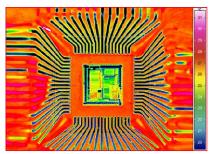
Smallest defects like point and line shunts, oxide failures, transistor and diode failures on a PCB surface and in IC's can be detected and displayed in x and y positions. Additionally, it is possible to analyse stacked-die packages or multi-chip modules in z-direction with merely changing the lock-in frequency.



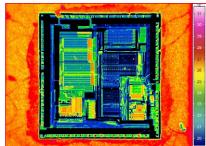
The modular test bench offers the following benefits:

- Online lock-in measurement with the highest sensitivity
- Complete and detailed microscopy analysis
- Geometrical resolution up to 1.3 μm per pixel with microscope lenses
- Thermal resolution in the microkelvin range
- Multi-layer analysis
- Automatic scanning of larger samples due to precision mechanics

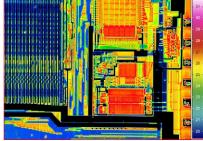




 $100\,mm$ telephoto lens with 500 mm close-up; pixel resolution 75 μm



1× microscopic lens; pixel resolution 15 μm



3× microscopic lens; pixel resolution 5 μm

Plano TX 75024 | USA



Automated Testing Solution E-LIT

Electronic/Semiconductor Testing Using Active Lock-in Thermography

Technical Specifications

Measuring chamber		
Infrared thermographic camera	High-end camera – ImageIR® or VarioCAM® HD head	Active Online Testili
Detector (cooled)	(1,280 × 1,024) / (640 × 512) IR pixels	
Detector (uncooled)	(1,024 × 768) / (640 × 480) IR pixels	
Spectral range	(2 5) μm or (7.5 14) μm	roses — — — — — — — — — — — — — — — — — —
Infrared image frequency	Up to 355 Hz @ (640×512) IR pixels	
Available lenses	12 mm, 25 mm, 50 mm, close-ups, microscopes 1×, 3×, 8× up to 2 μm per pixel	
Electrical excitation source	4 Quadrant power supply or other special power supply e.g. Keithley	
Optional		
X, Y axis sample moving table		
Z axis for camera positioning and focus adaption		
Autofocus for camera		
Contact probes for 4 point measurement		
Evaluation unit		
Dimensions	(560 × 670 × 840) mm (W × H × D)	
PC	19" industry PC	
Power supply	230 V AC / 110 V AC	
Weight	60 kg (incl. PC)*	
Test bench/rollable base		
Dimensions	(1180 × 1280 × 800) mm/(1150 × 750 × 800) mm (B × H × T)	
Weight	80 kg/150 kg	
		* 1 1 1 1 1 1 1

* depending on model

Software

- Operational software with comprehensive analysis options in laboratory conditions
- Software add-on for automatic error classification based on parameter settings
- Intuitive user interface for easy operation
- Real-time display of the object being measured in various states
- Multifaceted memory options for image data and measurement results
- Alternative 0°, 90° or customised set phase angle image for representation of complex intensity information
- Merging live and amplitude image
- Optional: IV measurement, under sampling, drift compensation, DC-mode, power loss measurement, user and protocol administration, interface preparation: e.g. Profibus, Ethernet

